

**SMT4N65**

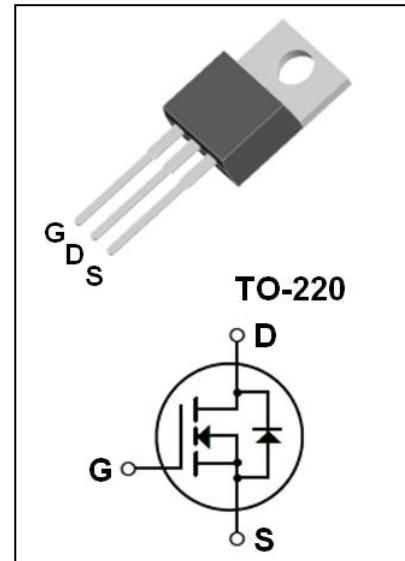
650V N-Channel MOSFET

● Features:

- 4.0A, 650V, $R_{DS(on)(Typ)} = 2.2\Omega$ @ $V_{GS} = 10V$
- Low Gate Charge
- Low C_{rss}
- 100% Avalanche Tested
- Fast Switching
- Improved dv/dt Capability

● Application:

- High Frequency Switching Mode Power Supply
- Active Power Factor Correction

**Absolute Maximum Ratings (Tc=25°C unless otherwise noted)**

Symbol	Parameter		Value	Unit	
V_{DSS}	Drain-Source Voltage		650	V	
I_D	Drain Current	- Continuous ($T_c = 25^\circ C$)	4.0*	A	
		- Continuous ($T_c = 100^\circ C$)	2.5*	A	
I_{DM}	Drain Current	-Pulsed	(Note 1)	16*	A
V_{GSS}	Gate-Source Voltage		± 30	V	
E_{AS}	Single Pulsed Avalanche Energy		240	mJ	
I_{AR}	Avalanche Current		4.0	A	
E_{AR}	Repetitive Avalanche Energy		10.0	mJ	
dv/dt	Peak Diode Recovery dv/dt		4.5	V/ns	
P_D	Power Dissipation ($T_c = 25^\circ C$)		33	W	
	-Derate above $25^\circ C$		0.26	W/ $^\circ C$	
T_j	Operating Junction Temperature		150	$^\circ C$	
T_{stg}	Storage Temperature Range		-55 to +150	$^\circ C$	

* Drain Current Limited by Maximum Junction Temperature.

Thermal Characteristics

Symbol	Parameter	Max	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case	3.79	$^\circ C / W$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	62.5	$^\circ C / W$



SMT4N65

650V N-Channel MOSFET

Electrical Characteristics (Tc=25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
Off Characteristics						
BV _{DSS}	Drain-source Breakdown Voltage	V _{GS} =0V, I _D =250μA	650	--	--	V
△BV _{DSS} /△T _J	Breakdown Voltage Temperature Coefficient	I _D =250μA (Referenced to 25°C)	--	0.65	--	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =650V, V _{GS} =0V	--	--	1	μA
		V _{DS} =520V, Tc=125°C	--	--	10	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} =+30V, V _{DS} =0V	--	--	100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} =-30V, V _{DS} =0V	--	--	-100	nA
On Characteristics						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D =250μA	2.0	--	4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} =10 V, I _D =2.0A	--	2.2	2.6	Ω
g _{FS}	Forward Transconductance	V _{DS} =40 V, I _D =2.0A (Note4)	--	3.6	--	S
Dynamic Characteristics						
C _{iss}	Input Capacitance	V _{DS} =25V, V _{GS} =0V, f=1.0MHz	--	560	--	pF
C _{oss}	Output Capacitance		--	62	--	pF
C _{rss}	Reverse Transfer Capacitance		--	10	--	pF
Switching Characteristics						
t _{d(on)}	Turn-On Delay Time	V _{DD} = 325 V, I _D = 4.0 A, R _G = 25 Ω (Note4,5)	--	30	--	ns
t _r	Turn-On Rise Time		--	75	--	ns
t _{d(off)}	Turn-Off Delay Time		--	60	--	ns
t _f	Turn-Off Fall Time		--	55	--	ns
Q _g	Total Gate Charge	V _{DS} = 520 V, I _D = 4.0 A, V _{GS} = 10 V (Note4,5)	--	12	--	nC
Q _{gs}	Gate-Source Charge		--	4.0	--	nC
Q _{gd}	Gate-Drain Charge		--	4.8	--	nC
Drain-Source Diode Characteristics and Maximum Ratings						
I _S	Maximum Continuous Drain-Source Diode Forward Current		--	--	4.0	A
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current		--	--	16	A
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0V, I _S =4.0A	--	--	1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0V, I _S =4.0A, d I _F /dt=100A/μs (Note4)	--	330	--	ns
Q _{rr}	Reverse Recovery Charge		--	2.67	--	μC

Notes:

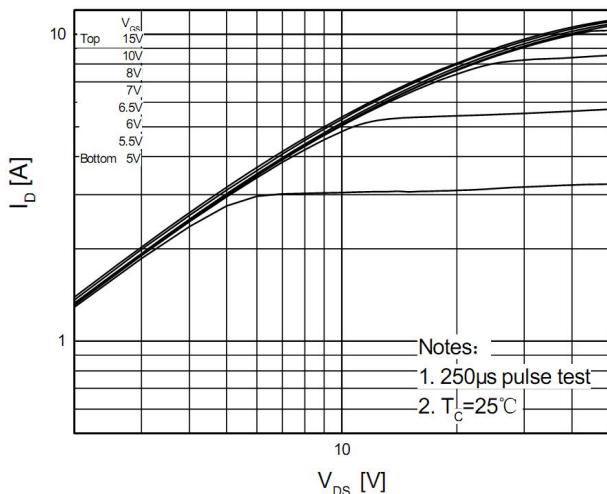
1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.
2. L = 25.0mH, I_{AS} = 4.0A, V_{DD} = 50V, R_G = 25 Ω, Starting T_J = 25°C.
3. I_{SD}≤4.0A, di/dt≤200A/μs, V_{DD}≤BV_{DSS}, Starting T_J = 25°C.
4. Pulse Test : Pulse Width ≤300 μ s, Duty Cycles≤2%.
5. Essentially Independent of Operating Temperature.



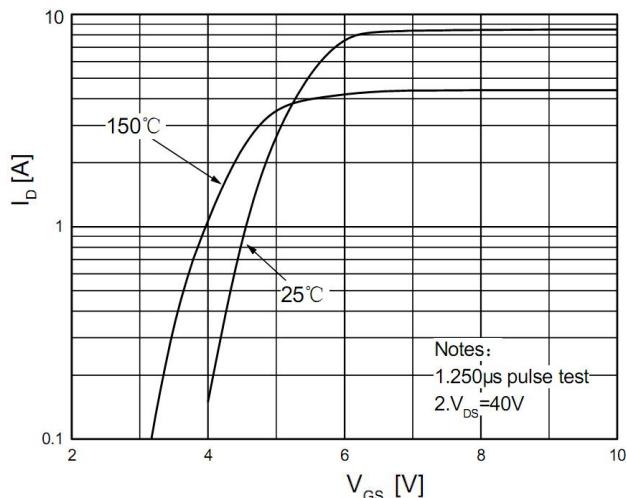
SMT4N65

650V N-Channel MOSFET

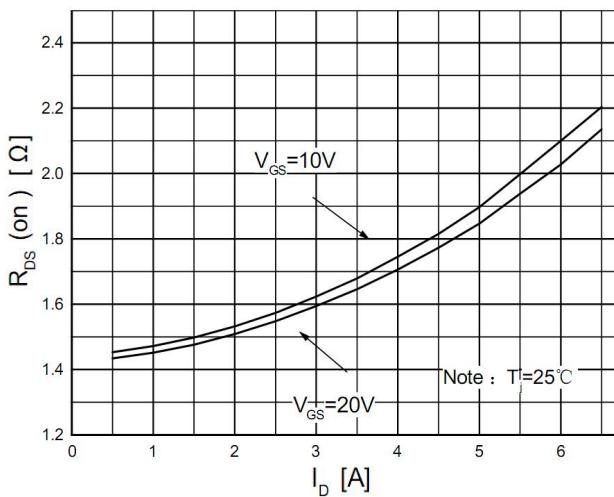
On-Region Characteristics



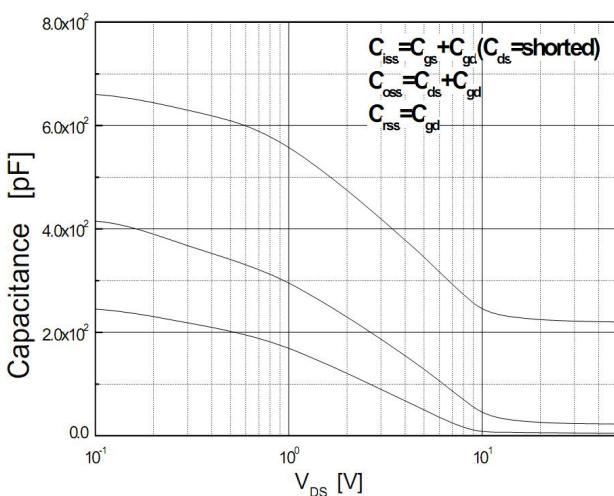
Transfer Characteristics



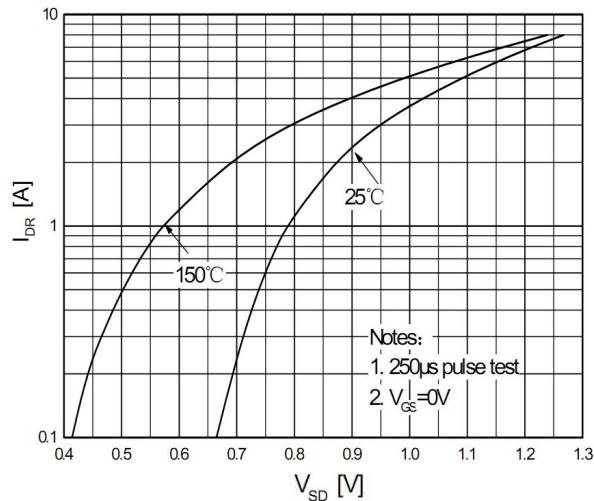
On-Resistance Variation vs. Drain Current and Gate Voltage



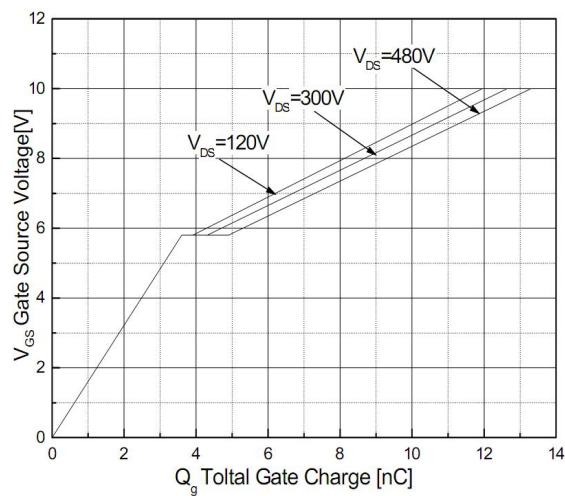
Capacitance Characteristics



Body Diode Forward Voltage Variation vs. Source Current and Temperature



Gate Charge Characteristics

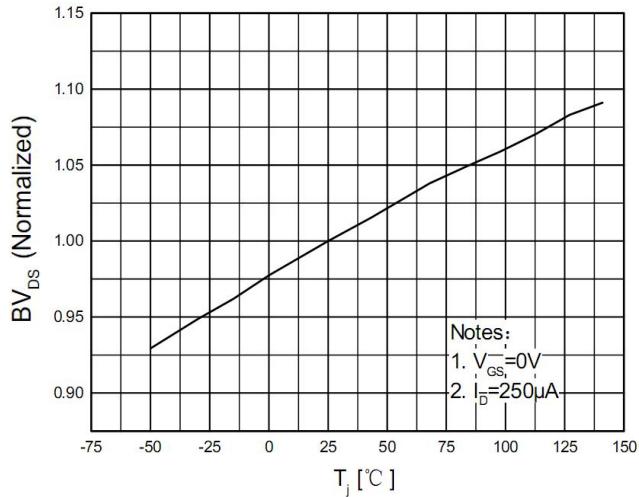




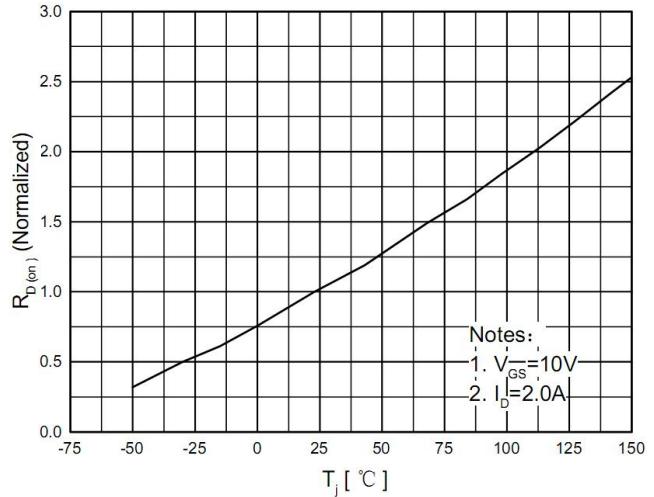
SMT4N65

650V N-Channel MOSFET

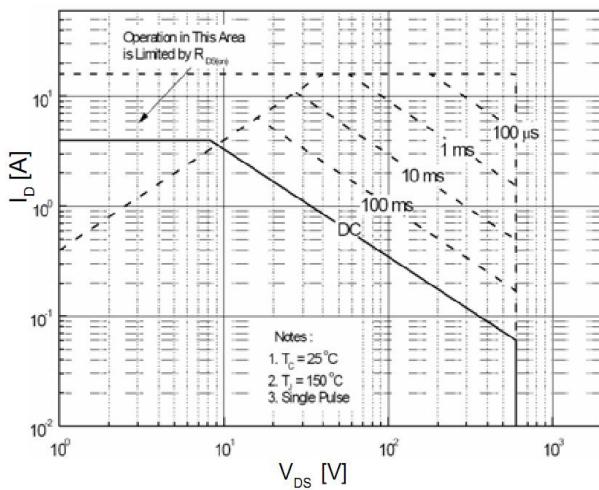
Breakdown Voltage Variation vs. Temperature



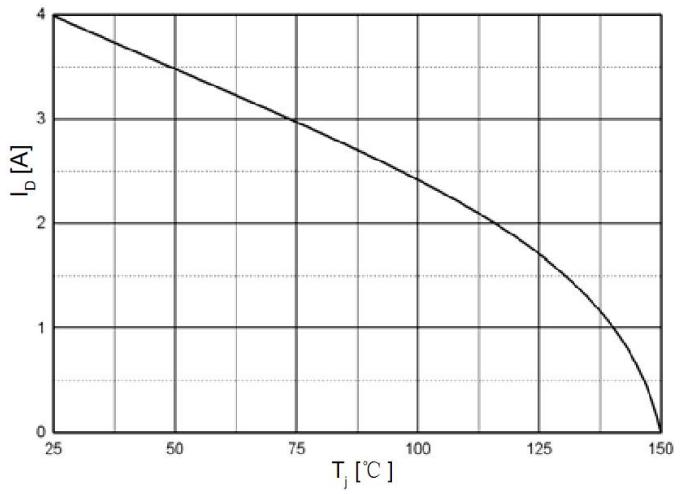
On-Resistance Variation vs. Temperature



Maximum Safe Operating Area



Maximum Drain Current Vs. Case Temperature





SMT4N65

650V N-Channel MOSFET

TO-220 MECHANICAL DATA

UNIT: mm

SYMBOL	min	nom	max	SYMBOL	min	nom	max
A	4.00		4.80	E	9.70		10.70
B	1.15		1.45	e		2.54	
B1	0.90		1.40	F	1.10		1.40
b1	0.65		0.95	L	12.50		14.50
c	0.30		0.50	L1	2.90	3.40	3.90
D	14.40		16.40	Q	2.50		3.10
D1	5.90		6.90	Q1	2.00		3.00
				φ P	3.60		4.00

